# MOSFET – Power, N-Channel, SUPERFET<sup>®</sup> III, Easy Drive 650 V, 44 A, 70 mΩ

# FCB070N65S3

## Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advance technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET is very suitable for various AC/ DC power conversion for system miniaturization and higher efficiency.

## Features

- 700 V @  $T_J = 150^{\circ}C$
- $R_{DS(on)} = 62 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 78 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 715 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

### Applications

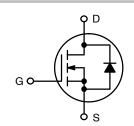
- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar



# **ON Semiconductor®**

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V <sub>DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX		
650 V	70 mΩ @ 10 V	44 A		

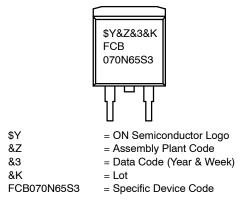


POWER MOSFET



D<sup>2</sup>-PAK CASE 418AJ

# MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	650	V		
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V	
		AC (f > 1 Hz)	±30	V	
Ι <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	44	Α	
		Continuous (T <sub>C</sub> = 100°C)	28		
I <sub>DM</sub>	Drain Current	Pulsed (Note 1)	110	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		214	mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)		4.8	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		3.12	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		20		
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C)	312	W	
		Derate Above 25°C	2.5	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1	300	°C		

#### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 4.8 \text{ A}$ ,  $R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}C$ . 3.  $I_{SD} \le 44 \text{ A}$ , di/dt  $\le 200 \text{ A}/\mu\text{s}$ ,  $V_{DD} \le BV_{DSS}$ , starting  $T_J = 25^{\circ}C$ .

### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
	Thermal Resistance, Junction to Ambient, Max. (Note 4)	40	

4. Device on 1 in<sup>2</sup> pad 2 oz copper pad on 1.5 x 1.5 in. board of FR-4 material.

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Reel Size	Tape Width	Shipping <sup>†</sup>
FCB070N65S3	FCB070N65S3	D <sup>2</sup> -PAK	330 mm	24 mm	800 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
OFF CHARACT	ERISTICS	•	-				
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650	-	-	V	
		$V_{GS}$ = 0 V, $I_{D}$ = 1 mA, $T_{J}$ = 150°C	700	-	-	V	
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 1$ mA, Referenced to $25^{\circ}C$	-	0.72	-	V/°C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	μΑ	
		$V_{DS}$ = 520 V, $V_{GS}$ = 0 V, $T_{C}$ = 125 °C	-	2.2	-	1	
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±100	nA	
ON CHARACTE	RISTICS	•					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1.0$ mA	2.5	-	4.5	V	
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A	-	62	70	mΩ	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 22 A	-	29	-	S	
DYNAMIC CHA	RACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz	-	3090	-	pF	
C <sub>oss</sub>	Output Capacitance	-	-	68	-	pF	
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	715	-	pF	
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	-	104	-	pF	
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V	$V_{DS}$ = 400 V, I <sub>D</sub> = 22 A, V <sub>GS</sub> = 10 V (Note 5)	-	78	-	nC	
Q <sub>gs</sub>	Gate to Source Gate Charge		-	18	-	nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	1	-	30	-	nC	
ESR	Equivalent Series Resistance	f = 1 MHz	-	0.6	-	Ω	
SWITCHING CH	IARACTERISTICS						
t <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 22 \text{ A},$	-	26	-	ns	
t <sub>r</sub>	Turn-On Rise Time	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 5)	-	52	-	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time		_	89	-	ns	
t <sub>f</sub>	Turn-Off Fall Time	1	-	16	-	ns	
SOURCE-DRAI	N DIODE CHARACTERISTICS						
۱ <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current			-	44	Α	
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current			-	110	Α	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 22 A	-	-	1.2	V	
t <sub>rr</sub>	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 22 A,$	-	435	-	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— dI <sub>F</sub> /dt = 100 A/μs	-	9.2	_	μC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Essentially independent of operating temperature typical characteristics.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

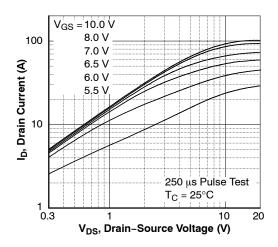
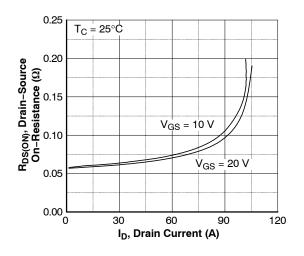
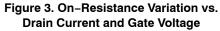


Figure 1. On–Region Characteristics





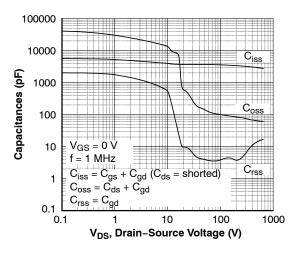


Figure 5. Capacitance Characteristics

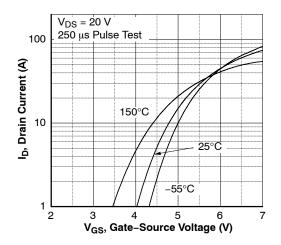
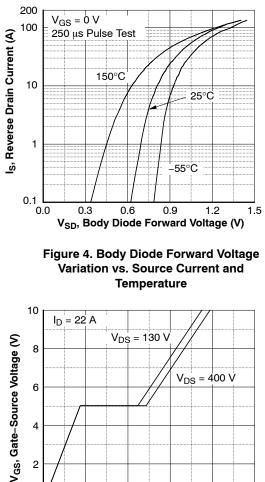


Figure 2. Transfer Characteristics



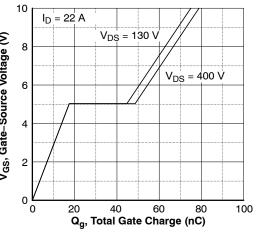


Figure 6. Gate Charge Characteristics

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

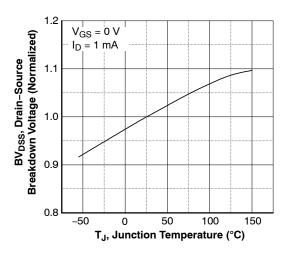


Figure 7. Breakdown Voltage Variation vs. Temperature

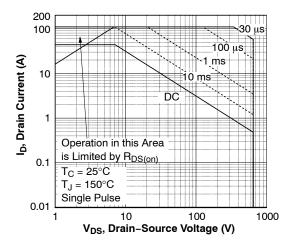


Figure 9. Maximum Safe Operating Area

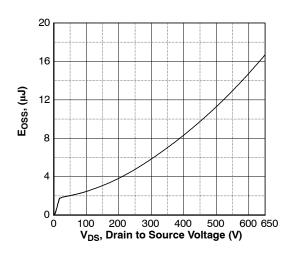


Figure 11. E<sub>OSS</sub> vs. Drain to Source Voltage

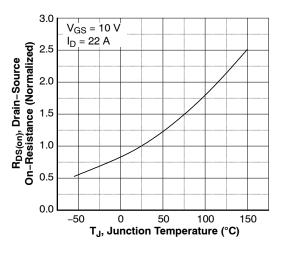


Figure 8. On–Resistance Variation vs. Temperature

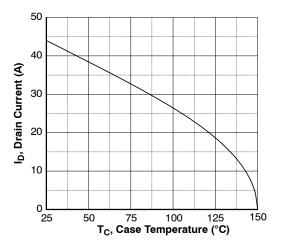


Figure 10. Maximum Drain Current vs. Case Temperature

# TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

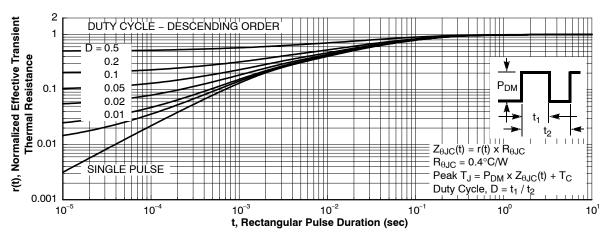
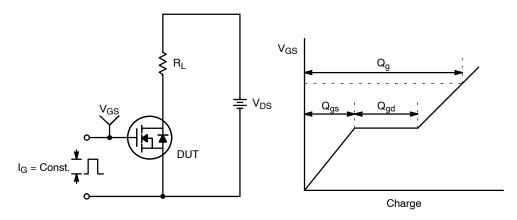


Figure 12. Transient Thermal Response Curve





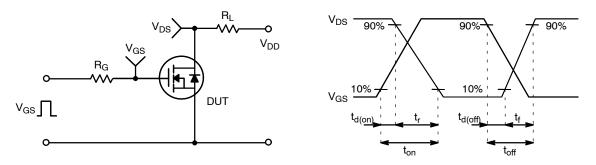
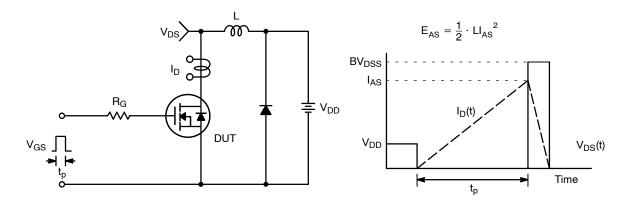


Figure 14. Resistive Switching Test Circuit & Waveforms





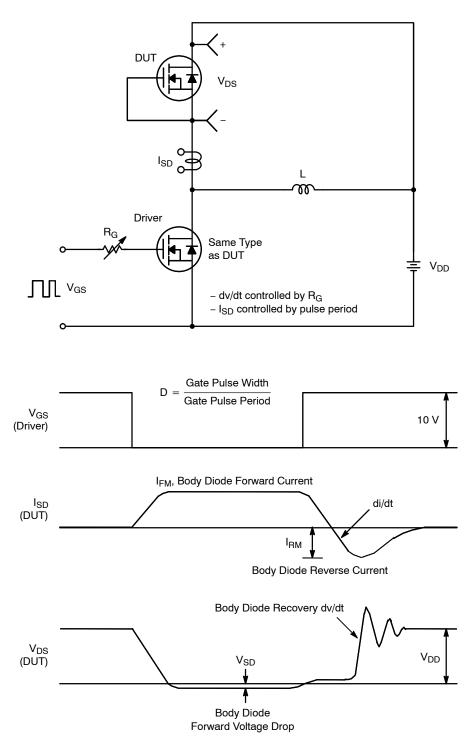
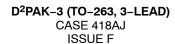


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

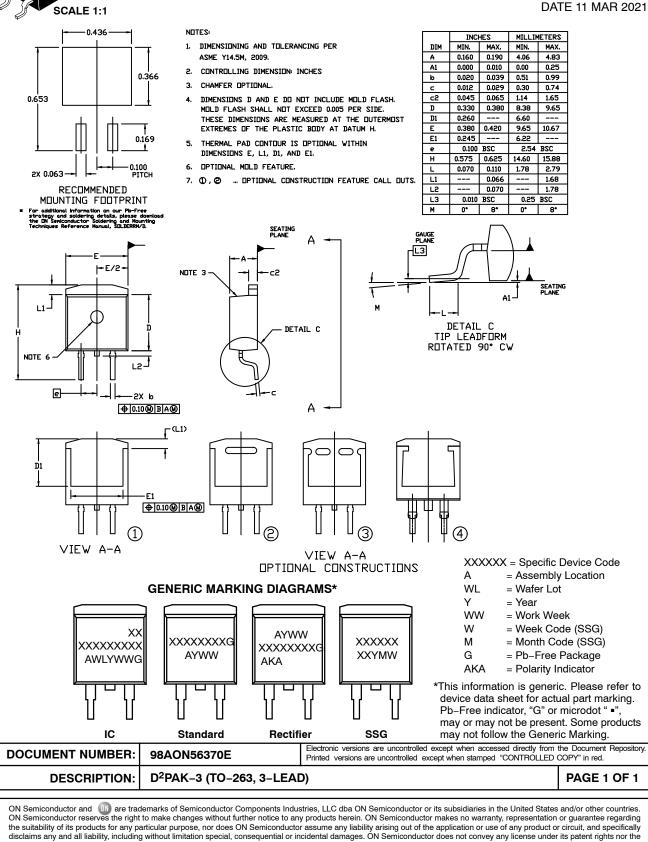
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#### **MECHANICAL CASE OUTLINE** PACKAGE DIMENSIONS









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